

INTERNATIONAL STANDARD

NORME INTERNATIONALE

**Field device integration (FDI) –
Part 1: Overview**

**Intégration des appareils de terrain (FDI) –
Partie 1: Vue d'ensemble**

Withdrawing



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INTERNATIONAL
ELECTROTECHNICAL
COMMISSION

COMMISSION
ELECTROTECHNIQUE
INTERNATIONALE

ICS 25.040.40; 35.100

ISBN 978-2-8322-2622-3

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FIELD DEVICE INTEGRATION (FDI) –

Part 1: Overview

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/337/CDV	65E/421/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

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A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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INTRODUCTION

The IEC 62657 series has the general title "Field Device Integration (FDI)" and the following parts:

- Part 1: Overview
- Part 2: FDI Client
- Part 3: FDI Server
- Part 4: FDI Packages
- Part 5: FDI Information Model
- Part 6: FDI Technology Mapping
- Part 7: FDI Communication Devices
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